

<b>FORM PTO-1449/A and B (Modified)</b>  <b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>				APPLICATION NO.: Unassigned		ATTY. DOCKET NO.: S1022.81113US00	
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				APPLICANT: S1022.81113US00			
				GROUP ART UNIT: Unassigned		EXAMINER: Unassigned	
Sheet	1	of	1				

#### U.S. PATENT DOCUMENTS


Examiner's Initials	Cite No.	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication or of issue of Cited Document MM-DD-YYYY
		Number	Kind Code		
GMR		5,158,907		Fitzgerald, Jr.	10/27/92
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		4,396,929		Ohki et al.	08/02/83
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#### FOREIGN PATENT DOCUMENTS

Examiner's Initials	Cite No.	Foreign Patent Document			Name of Patentee or Applicant of Cited Document (not necessary)	Date of Publication of Cited Document MM-DD-YYYY	Translation (Y/N)
		Office/ Country	Number	Kind Code			

#### OTHER ART — NON PATENT LITERATURE DOCUMENTS

Examiner's Initials	Cite No	Include name of the author (in CAPITAL LETTERS) title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, relevant page(s), volume-issue number(s), publisher, city and/or country where published.	Translation (Y/N)
GMR		French Search Report from French Patent Application No. 03/04152, filed April 3, 2003	
		Patent Abstracts of Japan, vol. 2003, no. 04, April 2, 2003 & JP 2002 359189 A (Mitsubishi Materials Silicon Corp.; Mitsubishi Materials Corp.), December 13, 2002	
		Patent Abstracts of Japan vol. 011, no. 031 (E-475), January 29, 1987 & JP 61 198713 A (Fujitsu Ltd.) September 3, 1986	

EXAMINER 	DATE CONSIDERED 6/21/06
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#EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.